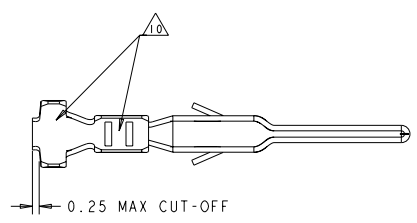
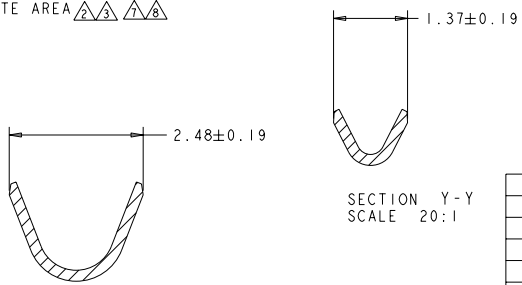
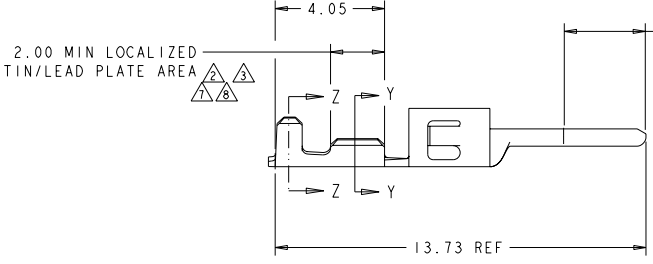


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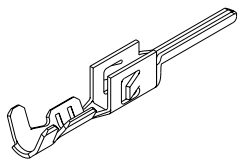
REV	DATE	BY	APPD
A	17-JUL-03	KW	CJ
B	05-JAN-05	KW	CJ
B1	24-FEB-04	KW	CJ



- △ 2.5 μm MIN BRIGHT TIN/LEAD ENTIRE STOCK OVER 1.27 μm MIN NICKEL ENTIRE STOCK.
- △ 0.38 μm MIN GOLD IN LOCALIZED GOLD PLATE AREA, 2.5 μm MIN BRIGHT TIN/LEAD IN LOCALIZED TIN/LEAD PLATE AREA, BOTH OVER 1.27 μm MIN NICKEL ON ENTIRE STOCK.
- △ 0.76 μm MIN GOLD IN LOCALIZED GOLD PLATE AREA, 2.5 μm MIN BRIGHT TIN/LEAD IN LOCALIZED TIN/LEAD PLATE AREA, BOTH OVER 1.27 μm MIN NICKEL ON ENTIRE STOCK.
- 4. WIRE RANGE 26-30 AWG.
- 5. INSULATION RANGE 0.89-1.52
- △ 2.5 μm MIN BRIGHT TIN ENTIRE STOCK OVER 1.27 μm MIN NICKEL ENTIRE STOCK.
- △ 0.38 μm MIN GOLD IN LOCALIZED GOLD PLATE AREA, 2.5 μm MIN BRIGHT TIN IN LOCALIZED TIN PLATE AREA, BOTH OVER 1.27 μm MIN NICKEL ON ENTIRE STOCK.
- △ 0.76 μm MIN GOLD IN LOCALIZED GOLD PLATE AREA, 2.5 μm MIN BRIGHT TIN IN LOCALIZED TIN PLATE AREA, BOTH OVER 1.27 μm MIN NICKEL ON ENTIRE STOCK.
- △ NOTE DELETED.
- △ TIN PLATING THICKNESS INSIDE WIRE AND INSULATION BARRELS TO BE 1.27 μm MIN.



△ 8	1-794613-2
△ 7	1-794613-1
△ 6	1-794613-0
△ 5	794613-3
△ 4	794613-2
△ 3	794613-1
FINISH	PART NUMBER



METRIC

DIMENSIONS:		TOLERANCES UNLESS OTHERWISE SPECIFIED:		DWN		Tyco Electronics	
0	PLC	±		J	RUDY	29AUG2000	Harrisburg, PA 17105-3600
1	PLC	±		W	DAVIS	29AUG2000	
2	PLC	±	00.13	W	DAVIS	29AUG2000	
3	PLC	±		NAME			
4	PLC	±		PLUG CONTACT, CRIMP SNAP, 26-30 AWG, LOOSE PIECE, MICRO MATE-N-LOK(TM)			
MATERIAL		ANGLE		APPLICATION SPEC		SIZE	
0.20 THK BRASS		°				A2 00779 ©=794613	
CUSTOMER DRAWING		WEIGHT		SCALE		SHEET	
				10:1		1 OF 1 REV B1	